

REFLOW OVEN YX 830

SPECIFICATION	YX 830
Heating zone quantity	Upper 4 / Lower 4
Length of the heating zone	1400 X 300 mm
Heating type	Upper 4 Hot Air Heating Zones + Lower 4 Heating Zones
Cooling zone quantity	1
Maximum width of PCB board	280 mm
Operation direction	Left \rightarrow Right



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Delivery option	Net transmission + Chain transmission
Speed of conveyer belt	0 – 2000 mm/min
Power supply	Three-phase Rive-wire 380V ± 10% 50Hz
Peak power	11 KW
Heating up time	Around 30 minutes
Temperature control range	Room Temperature – 400°C
Temperature control mode	PID Closed-loop Control
Temperature control accuracy	±5°C
PCB temperature distribution deviation	±5°C
Overall dimensions	2500 x 710 x 1250 mm
Machine weight	240 КG